



MRUSB-5AB-RV5-x-S306

鍍層厚度：

Blank : 1u"

2 : 15u"

3 : 30u"

SPECIFICATIONS

Electrical:

- 1.Current Rating: 1.0A
- 2.Contact Resistance: 30 mΩ Max
- 3.Dielectric Withstanding Voltage: 100 V for 1 min
- 4.Insulation Resistance: 100 MΩ Min

Material:

- 1.Housing: LCP,UL 94V-0
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS

Finish:

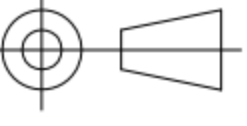
- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Tin under Plated surface layer

P.C.B LAYOUT MOUNTING PATTEN



东莞市溪榜电子有限公司

DONG GUAN XI BANG ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :		Up to 5 ±0.2	3RD. ANGEL'S		UNITS	MM
		Above 5 ~ 15 ±0.3				
		Above 15 ~ 30 ±0.4				
		Above 30 ~ 50 ±0.5				
		Angle ±0.3°				

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR	
Jack Lu	04/22/15					
CHECKED BY:	DATE	FINISH		MODLE	MICRO USB AB TYPE 反向 牛角型	
Jacky Chen	04/22/15	SCALE	1 : 1	DWG NO.	MRUSB-5AB-RV5-x-S306	SIZE
APPROVED BY:	DATE					A4
Tony Kao	04/22/15	SHEET NO.	1 of 1	PART NO.	MRUSB-5AB-RV5-x-S306	VER
						A0

2	更新尺寸及材質和鍍層	Jack	042215
1	新增鍍層厚度選項	Jack	042115
ITEM NO.	DESCRIPTION	DRAWN	DATE